



# Product Change Notification

## 113088 - 01

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# Product Change Notification

**Change Notification #:** 113088 - 01  
**Change Title:** Intel® SSD DC S3500 Series (80GB, 120GB, 160GB, 240GB, 300GB, 400GB, 480GB, 600GB, 800GB)  
PCN 113088-01  
Product Material  
Add Second Source, Second Source Connector, Base and Top Cover,  
**Reason for Revision: Second Source had not implemented, adding Top cover**  
**Date of Publication:** November 04, 2014

**Key Characteristics of the Change:**  
Product Material

## Forecasted Key Milestones:

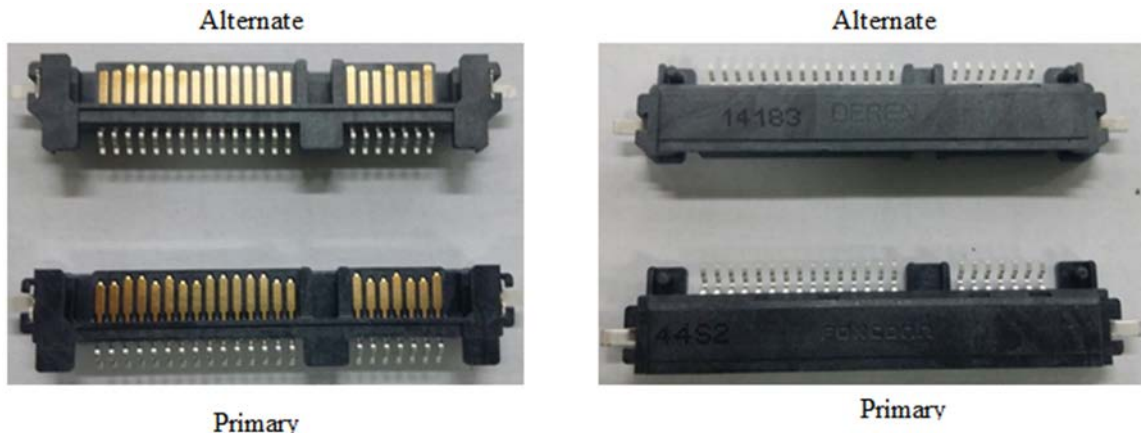
Date Customer Must be Ready to Receive Post-Conversion Material:	Nov 21, 2014
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## Description of Change to the Customer:

**Reason for Revision: Second Source had not implemented adding Top cover**

Intel is adding a second source Serial ATA connector manufacture and an alternate case manufacturer for the base and top cover of the DC S3500 Series in order to ensure a continuous supply of the Intel® SSD DC S3500 Series products.

The second source SATA connector is made to the same specifications as the primary SATA connector.

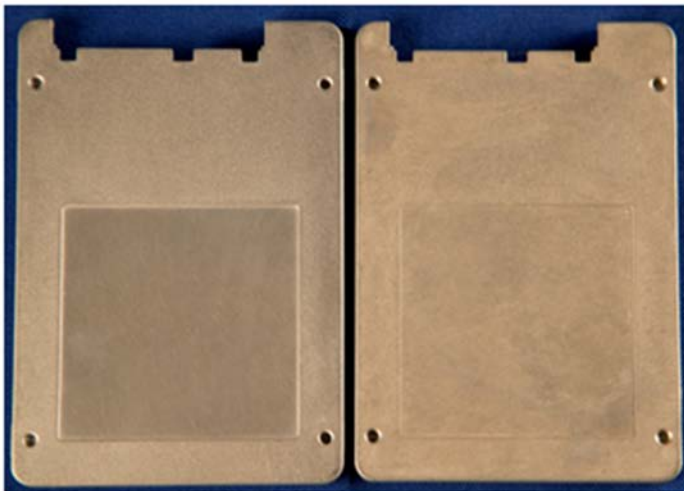




Alternate

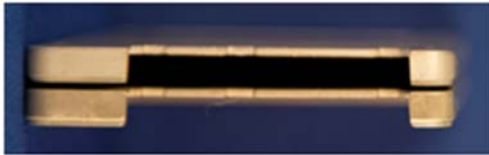
Primary

The second source base and top cover are made to the same specifications as the primary base and top cover.



Alternate

Primary



Alternate

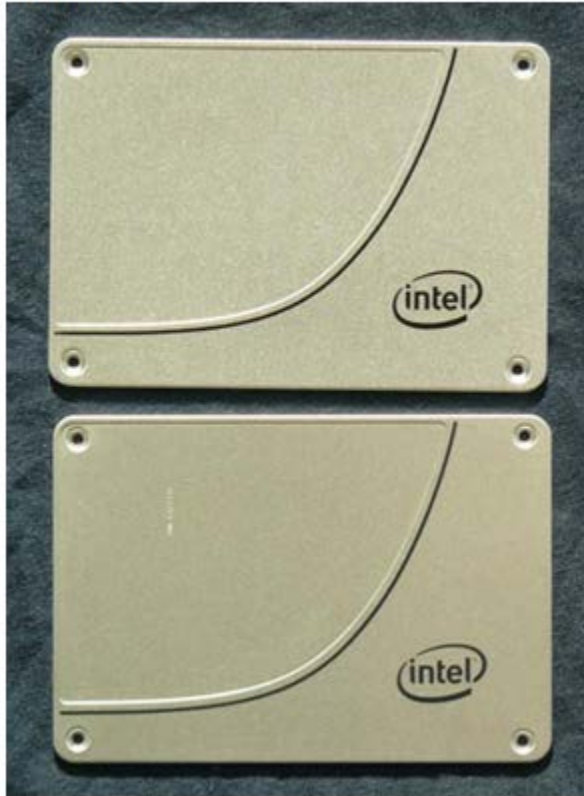
Primary



Alternate

Primary

Top Cover



Alternate

Primary

**Customer Impact of Change and Recommended Action:**

Intel anticipates no product impact with the addition of the second source SATA connector, base and top cover. Re-qualification is not recommended.

Milestone dates are estimates and subject to change based on business and operational conditions.

### Products Affected / Intel Ordering Codes:

Product Code	MM#
SSDSC2BB080G401	927197
SSDSC2BB120G401	927198
SSDSC2BB160G401	927199
SSDSC2BB240G401	927200
SSDSC2BB300G401	927201
SSDSC2BB480G401	927202
SSDSC2BB800G401	927204
SSDSC2BB080G4	927205
SSDSC2BB120G4	927206
SSDSC2BB160G4	927207
SSDSC2BB240G4	927208
SSDSC2BB300G4	927209
SSDSC2BB480G4	927210
SSDSC2BB800G4	927211
SSDSC2BB600G401	928390
SSDSC2BB600G4	930361

### PCN Revision History:

Date of Revision:	Revision Number:	Reason:
June 27, 2014	00	Originally Published PCN
November 4, 2014	01	Second source had not implemented, adding top cover.